DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD AND SYSTEM FOR PROVIDING SEAMLESS CONNECTIVITY AND COMMUNICATION IN A MULTI-BAND MULTI-PROTOCOL HYBRID WIRED/WIRELESS NETWORK, the specification of which

(check one)	[X] is attached hereto.		
	[] was filed on amended on		ation Serial No, was as U.S. Patent No.
I hereby state specification, inc	that I have reviewed and cluding the claims, as amend	d understand the conded by any amendmen	ntents of the above-identified treferred to above.
I acknowledge application in ac	the duty to disclose inforcordance with Title 37, Cod	mation that is materi le of Federal Regulation	ial to the examination of this ons, §1.56(a).
foreign applicati below any foreig	ion(s) for patent or invento	or's certificate listed be inventor's certificate l	states Code, §119(a)-(d) of any below and have also identified having a filing date before that
P	RIOR FOREIGN APPLICA	TION(S)	Priority Claimed
(Number) (Country)	(Date Filed)	_ Yes/No
I hereby States provisiona	claim the benefit under Tall application(s) listed below	itle 35, United States v:	Code, §119(e) of any United
60 60	0/459,356 0/433,198 0/411,261 0/411,301 0/606,565		March 31, 2003 December 31, 2002 September 17, 2002 September 17, 2002 June 26, 2003
	tion Serial No.)		(Filing Date)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application or any international application designating the United States under Title 35, United States Code, §365 listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56, regarding events which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Number)	(Country)	(Date Filed)
(Number)	(Country)	(Date Filed)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

First	named	inven	tor:

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